

Title (en)

CLIP CONTACT ELEMENT FOR A PRINTED CIRCUIT BOARD AND METHOD FOR ITS PRODUCTION

Title (de)

KLIPPKONTAKTELEMENT FÜR EINE LEITERPLATTE UND VERFAHREN ZU DESSEN HERSTELLUNG

Title (fr)

CLIP ELEMENT DE CONTACT POUR UNE CARTE DE CIRCUIT IMPRIME ET SON PROCEDE DE PRODUCTION

Publication

EP 2965385 B1 20201209 (DE)

Application

EP 14707804 A 20140305

Priority

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- EP 2014054201 W 20140305

Abstract (en)

[origin: WO2014135557A1] The invention relates to a clip contact element (16) for a printed circuit board (12), comprising a contact core body (20). At least two inclined guiding elements (22) and at least two contact lip elements (24) extend outwards from the contact core body (20), and the contact core body (20) has at least one conductor contact portion (28). The invention further relates to a connection arrangement (10) with such a clip contact element (16) and to a method (80) for producing same.

IPC 8 full level

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CPC (source: EP)

H01R 12/585 (2013.01); **H01R 13/113** (2013.01); **H01R 43/16** (2013.01)

Citation (examination)

- US 5083927 A 19920128 - HERARD JAMES D [US], et al
- DE 10351716 A1 20040617 - BERGNER VERBINDUNGSTECHNIK GMB [DE]

Designated contracting state (EPC)

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